DECEMBER 1983-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

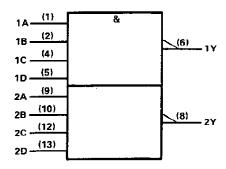
These devices contain two independent 4-input NAND gates.

The SN5420, SN54LS20, and SN54S20 are characterized for operation over the full military range of $-55\,^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$. The SN7420, SN74LS20, and SN74S20 are characterized for operation from 0 $^{\circ}\text{C}$ to 70 $^{\circ}\text{C}$.

FUNCTION TABLE (each gate)

	INP	UTS		QUTPUT
Α	В	С	D	Y
н	Н	Н	Н	Ļ
L	х	Х	х	Н
x	L	X	x	Н
х	Х	L.	×	н
х	X	Х	L	н

logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

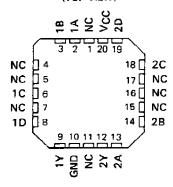
SN5420 . . . J PACKAGE
SN54LS20, SN54S20 . . . J OR W PACKAGE
SN7420 . . . N PACKAGE
SN74LS20, SN74S20 . . . D OR N PACKAGE
(TOP VIEW)

	_	_	1 1		L_	
1A	Ц	1	\cup	14	Ц	Vcc
1B	◁	2		13		2D
NC	□	3		12		2C
1 C	□	4		11		NC
1 D	₫	5		10		2B
1Y	d	6		9		2A
GND	d	7		8		2Y

SN5420 . . . W PACKAGE (TOP VIEW)

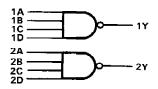
1A	ī	U 14	þ	1 D
1Y	2	13		1C
NC	3	12	Þ	1 B
/cc	4	11	Þ	GND
NC	5	10	Þ	2Y
2A	6	9	Þ	2D
2B	7	8	Þ	2C

SN54L\$20, SN54S20 . . . FK PACKAGE (TOP VIEW)



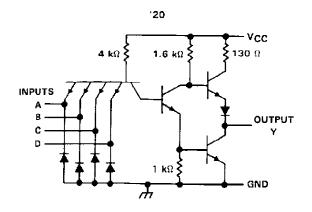
NC - No internal connection

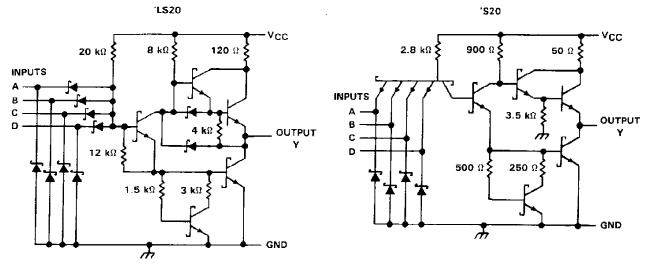
logic diagram



positive logic Y = $\overline{A \cdot B \cdot C \cdot D}$ or Y = \overline{A} + \overline{B} + \overline{C} + \overline{D}

schematics (each gate)





Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		7 V
Input voltage: '20, 'S20		5.5 V
'LS20		7 V
Operating free-air temperature range:	SN54'	55°C to 125°C
	SN74'	0°C to 70°C
Storage temperature range		65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.



recommended operating conditions

			SN5420			SN7420		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage	2			2			٧
VIL	Low-level input voltage			0.8			8.0	ν
lон	High-level output current			- 0.4			- 0.4	mΑ
loL	Low-level output current			16			16	MΑ
TA	Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				SN5420			SN742	0	UNIT
PARAMETER		TEST CONDITIONS T			MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	I _j = - 12 mA		-	– 1.5			1.5	٧
Voн	V _{CC} = MIN,	V _{IL} = 0.8 V, I _{OH} = - 0.4 mA	2.4	3.4		2.4	3.4		٧
VoL	VCC = MIN,	V _{IH} = 2 V, l _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧
l _l	V _{CC} - MAX,	V ₁ - 5.5 V			1		_	1	mΑ
ΊΗ	V _{CC} = MAX,	V ₁ = 2.4 V			40			40	μΑ
1 ₁ L	V _{CC} = MAX,	V ₁ = 0.4 V			- 1.6			- 1.6	mA
los§	V _{CC} = MAX		- 20		- 55	_ 18		- 55	mA
іссн	V _{CC} = MAX,	V = 0 V		2	4		2	4	mA
ICCL.	V _{CC} = MAX,	V ₁ = 4.5 V		6	11		6	11	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at V_{CC} = 5 V, T_{A} = 25°C. § Not more than one output should be shorted at a time.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	IDITIONS	MIN	TYP	мах	UNIT
[†] PLH	A	V	2 400 0	0 45 5		12	22	ns
ŧРНL	Any	Y	R _L = 400 Ω,	CL = 15 pF		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54LS20, SN74LS20 DUAL 4-INPUT POSITIVE-NAND GATES

recommended operating conditions

		SN54LS20			SN74LS20			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	٧	
V _{IH} High-level input voltage	2			2			٧	
V _{IL} Low-level input voltage			0.7			0.8	V	
IOH High-level output current			- 0.4			- 0.4	mΑ	
IOL Low-level output current			4			8	mΑ	
TA Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DA DAMACTED	i	TEST CONDITIONS T			SN54LS	20		SN74LS	20	LINIT
PARAMETER		1257 557/51116115				MAX	MIN	TYP\$	MAX	UNIT
Vik	VCC = MIN,	i = – 18 mA				- 1.5			– 1.5	V
v _{он}	V _{CC} = MIN,	VIL = MAX,	I _{OH} = - 0.4 mA	2.5	3,4		2.7	3.4		v
	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 4 mA		0.25	0.4			0.4	
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	10L = 8 mA					0.25	0.5	' '
11	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mΑ
liн	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μА
IIL	V _{CC} = MAX,	V! = 0.4 V				- 0.4			- 0.4	mΑ
IOS §	V _{CC} = MAX		<u> </u>	- 20		- 100	- 20		- 100	mA
Іссн	V _{CC} = MAX,	V = 0 V			0.4	0.8		0.4	8.0	mA
CCL	V _{CC} = MAX,	V ₁ = 4.5 V			1.2	2.2		1.2	2.2	mA

¹ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS			TYP	MAX	UNIT
tPLH .	Апу	>	$R_1 = 2 k\Omega$,	C _I = 15 pF		9	15	ns
[†] PHL	Ally	<u>.</u>	11 - 2 Kaz,	CL - 19 PF		10	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_{\Delta} = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

recommended operating conditions

			SN54S20			SN74S20			
		MIN	NOM	MAX	MIN	NOM	MAX	TINU	
V _{CC} Sup	ply voltage	4.5	5	5.5	4.75	5	5.25	V	
V _{IH} Hig	h-level input voltage	2			2	·		٧	
VIL Lov	v-level input voltage			8.0			0.8	V	
OH High	h-level output current			- 1			- 1	mΑ	
IOL LOV	v-level output current			20			20	mΑ	
Тд Оре	rating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

0.000.000	TEST CONDITIONS †	SN54S20	SN74S20	UNIT
PARAMETER	TEST CONDITIONS	MIN TYP# MAX	MIN TYP‡ MAX	UNIT
Vik	V _{CC} = MIN, I _f = -18 mA	-1.2	-1.2	٧
∨он	V _{CC} = MIN, V _{IL} = 0.8 V, I _{OH} = 1 mA	2.5 3.4	2.7 3.4	٧
Vol	V _{CC} = MIN, V _{1H} = 2 V, I _{OL} = 20 mA	0.5	0.5	٧
I _I	V _{CC} = MAX, V ₁ = 5.5 V	1	1	mА
IIH	V _{CC} = MAX, V _I = 2.7 V	50	50	μΑ
կ <u>լ</u>	V _{CC} = MAX, V _I = 0.5 V	-2	2	mΑ
los§	V _{CC} = MAX	-40 -100	-40 -100	mA
¹ ссн	V _{CC} = MAX, V _I = 0 V	5 8	5 8	mA
ICCL	V _{CC} = MAX, V _I = 4.5 V	10 18	10 18	mA

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN	TYP	МАХ	UNIT
tpLH			R_{\perp} = 280 Ω ,	C _L = 15 pF		3	4.5	п\$
tPHL	A B C B	Ų	11 200 30,	ο <u>Γ</u> - 19 μι		3	5	ns,
tpLH	A, B, C or D	Ť	R _L = 280 Ω,	C = 50 = 5		4.5		ns
^t PHL				C _L = 50 pF		5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07006BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BCA	Samples
JM38510/07006BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BDA	Samples
JM38510/07006BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BDA	Samples
JM38510/30007B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007B2A	Samples
JM38510/30007B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007B2A	Samples
JM38510/30007BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BCA	Samples
JM38510/30007BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BCA	Samples
JM38510/30007BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BDA	Samples
JM38510/30007BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BDA	Samples
M38510/07006BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BCA	Samples
M38510/07006BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BCA	Samples
M38510/07006BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BDA	Samples
M38510/07006BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BDA	Samples
M38510/30007B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007B2A	Samples
M38510/30007B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007B2A	Samples
M38510/30007BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BCA	Samples





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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
M38510/30007BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BCA	Samples
M38510/30007BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BDA	Samples
M38510/30007BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BDA	Samples
SN54LS20J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS20J	Samples
SN54LS20J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS20J	Samples
SN54S20J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S20J	Samples
SN54S20J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S20J	Samples
SN74LS20DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS20	Samples
SN74LS20DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS20	Samples
SN74LS20N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS20N	Samples
SN74LS20N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS20N	Samples
SN74LS20NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS20N	Samples
SN74LS20NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS20N	Samples
SN74LS20NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS20	Samples
SN74LS20NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS20	Samples
SN74S20D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S20	Samples
SN74S20D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S20	Samples
SN74S20N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S20N	Samples
SN74S20N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S20N	Samples
SN74S20NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S20N	Samples

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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74S20NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S20N	Samples
SNJ54LS20FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 20FK	Samples
SNJ54LS20FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 20FK	Samples
SNJ54LS20J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS20J	Samples
SNJ54LS20J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS20J	Samples
SNJ54LS20W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS20W	Samples
SNJ54LS20W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS20W	Samples
SNJ54S20J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S20J	Samples
SNJ54S20J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S20J	Samples
SNJ54S20W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S20W	Samples
SNJ54S20W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S20W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

PACKAGE OPTION ADDENDUM

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(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54LS20, SN54S20, SN74LS20, SN74S20:

Catalog: SN74LS20, SN74S20

Military: SN54LS20, SN54S20

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS20DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS20NSR	so	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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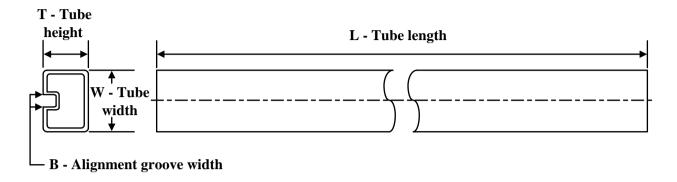
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS20DR	SOIC	D	14	2500	356.0	356.0	35.0
SN74LS20NSR	SO	NS	14	2000	356.0	356.0	35.0



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TUBE



*All dimensions are nominal

All difficusions are norminal	1	1				1		
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
JM38510/07006BDA	W	CFP	14	25	506.98	26.16	6220	NA
JM38510/30007B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/30007BDA	W	CFP	14	25	506.98	26.16	6220	NA
M38510/07006BDA	W	CFP	14	25	506.98	26.16	6220	NA
M38510/30007B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/30007BDA	W	CFP	14	25	506.98	26.16	6220	NA
SN74LS20N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS20N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS20NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS20NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74S20D	D	SOIC	14	50	506.6	8	3940	4.32
SN74S20N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S20N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S20NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74S20NE4	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS20FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS20W	W	CFP	14	25	506.98	26.16	6220	NA

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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